



*. R101, R102 and Q101 are reworked parts.

Built on PMP10350RevA PCB

PCB Number: PMP10350
PCB Rev: A

PCB
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Number: PMP10350	Rev: B	Designed for: Public Release	Mod. Date: 8/20/2014
SVN Rev: Not in version control	Assembly Variant: 001	Project Title: UCC28710 60W Flyback	Sheet Title:
Drawn By:	File: PMP10350_01.SchDoc	Sheet: 1 of 1	Size: B
Engineer: S Yu	Contact: http://www.ti.com/support	 http://www.ti.com © Texas Instruments 2014	

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